

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	32	Kurashima-tamayoshi.in.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 10:44
L2	0	tamayoshi-kurashima.in.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 10:44
L3	320	den-toru.in.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 10:44
L4	20	3 and (anode or anodization)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 11:48
L5	1	"20020167117"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 13:05
L6	1	"6610463".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 14:13
L7	0	"200253821"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 14:13
L8	163	Den-Tohru.in.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 14:14
L9	85	8 and (anode or anodization)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 14:57
L11	399	216/11.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 14:58
L12	406	216/11.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 14:58
L14	196	216/40.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:00

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L15	196	216/44.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 14:58
L16	1177	216/52.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 14:58
L17	176	216/53.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 14:59
L18	1337	216/83.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 14:59
L19	163	Den-tohru.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:01
L20	50	Imada-Aya.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:01
L21	194	19 or 20	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:02

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L22	89	21 and (anode or anodization)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:02
L23	19	21 and (anode or anodization). clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:02
L24	1146	(imprint or nano\$1imprint or nano\$1imprinting) and (anode or anodizing or anodization or electrolyte or electrolytic or electrolyzing)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:12
L25	694	L24 and @ay<="2003"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:12
L26	261	L25 and (mold or molding or mold or master)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:12
L27	4986	"S10" and capacitor	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L28	12111	"S10" and semiconductor	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L29	10254	L28 not L27	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L30	4	"7036913".pn. "6979076".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/21 15:14
L31	1146	(imprint or nano\$1imprint or nano\$1imprinting) and (anode or anodizing or anodization or electrolyte or electrolytic or electrolyzing)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L32	694	L24 and @ay<="2003"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14

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L33	261	L25 and (mold or molding or mold or master)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L35	3933	(imprint or nano\$1imprint or nano\$1imprinting) and (resist or photo\$1resist)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L36	1764	L35 and (mold or molding or mold or master)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L37	835	L36 and @ay<="2003"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L41	19	("4945050" "5036006" "5066587" "5100792" "5147740" "5149655" "5179022" "5236762" "5240842" "5240855" "5366850" "5371015" "5460831" "5478744" "5525510" "5541072" "5567503" "5654078" "5753418").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/12/21 15:14
L42	1146	(imprint or nano\$1imprint or nano\$1imprinting) and (anode or anodizing or anodization or electrolyte or electrolytic or electrolyzing or anoded)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L43	38210	(anode or anodizing or anodization or electrolyte or electrolytic or electrolyzing) and (mold or molding or mould)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L44	17472	(anode or anodizing or anodization) and (mold or molding or mould)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L45	13001	L44 and @ay<="2003"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L46	4735	(imprint or nano\$1imprint or nano\$1imprinting or protrusion or pattern) and L45	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L47	1033	(imprint or nano\$1imprint or nano\$1imprinting or protrusion) and L45	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14
L48	918	L47 not L34	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/12/21 15:14